



2022 Q2 Operating Result & Global PCB Market Trend

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- 1. Profile & 2022 Q2 Operating Result
- Introduction of the Photoresist Materials Division & Global PCB Market Trend

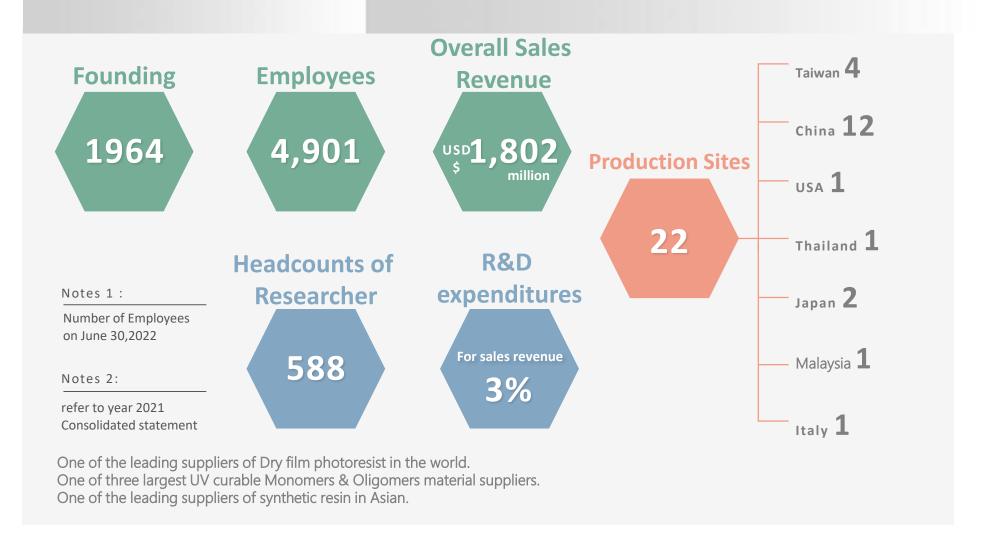


Profile



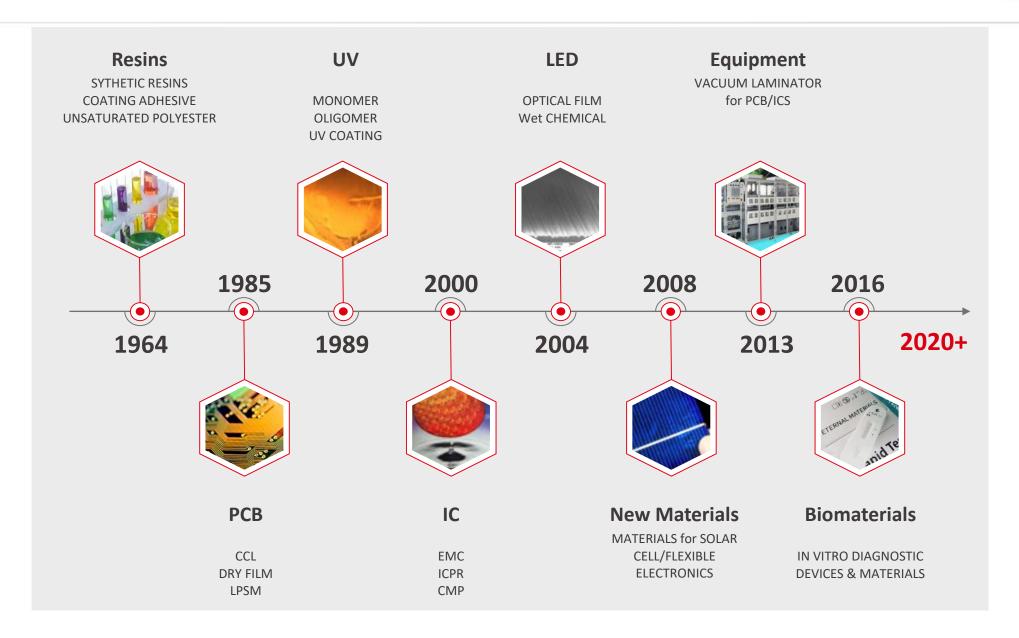


Core Business Manufacturing, processing and sales



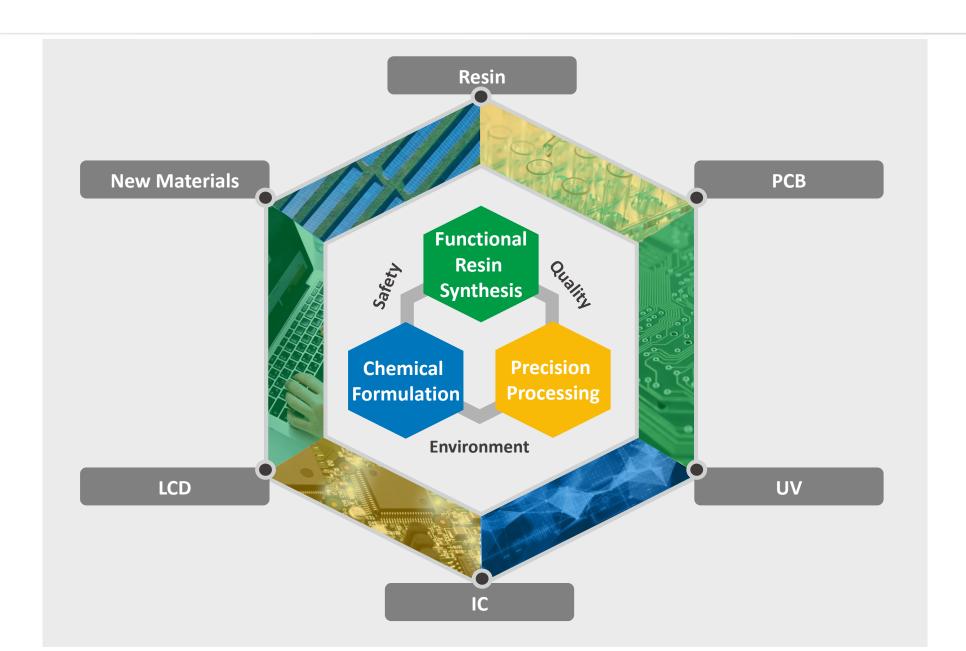
Development Milestones





Core Technology





New Development



Biomaterials

- Diagnostic Enzymes for **Molecular Biology**
- Diagnostic Enzymes for **Biochemistry of Blood**
- Dengue Virus-related **Monoclonal Antibodies**
- Biomedical Diagnostic materials

Advanced packing materials

- Liquid Epoxy Molding Compound
- Underfill

High performance resin materials

- Organic-inorganic hybrid materials
- Fluorocarbon polymer
- Nano-structured polymer
- Liquid crystal polymer
- High performance thermoplastic composites



New Applications Development

Functionality Improvement







Flexible electronics materials

- Dry Film Solder Mask
- **■** Polyimide; PI
- **■** Photosensitive polyimide
- **PSPI**

Green energy/energy storage materials

- Conductive polymer
- Solar cell and wind power materials
- Binder 、 Si/C 、 Electrolyte additives ■ Graphene for Lithium Battery

Environmental protection idea product

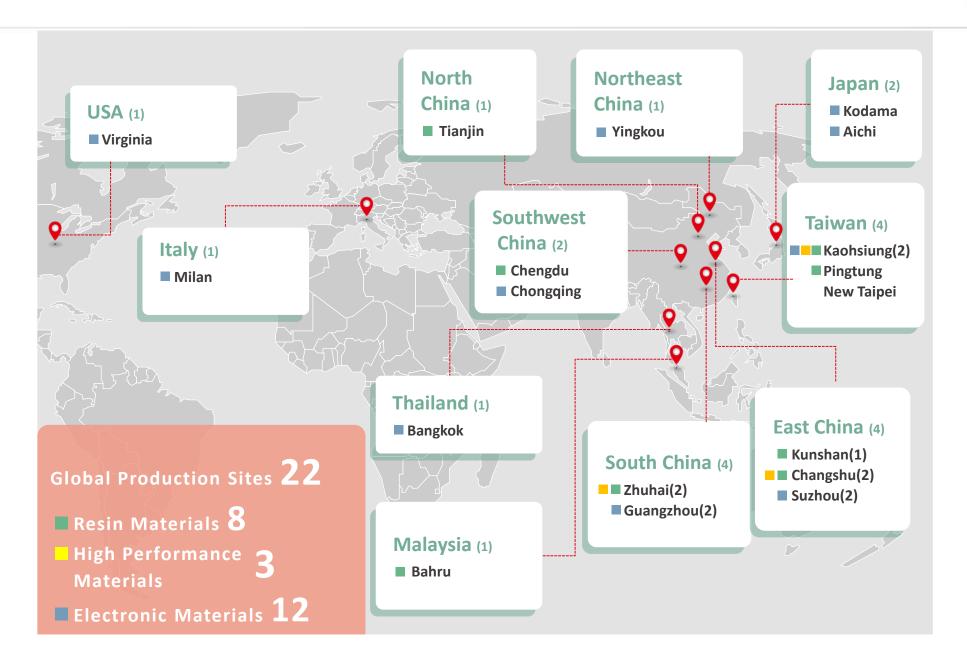
- Water-based resins
- **■** UV curable resins
- Lead/halogen/chromium-free materials



Biomass materials

Global Production Sites





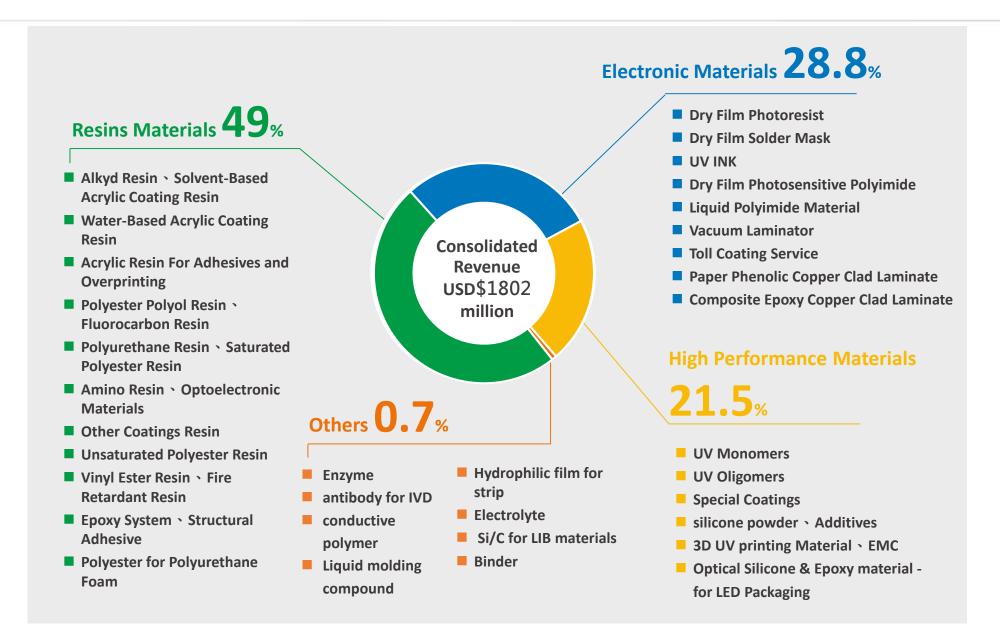
Global Service Network





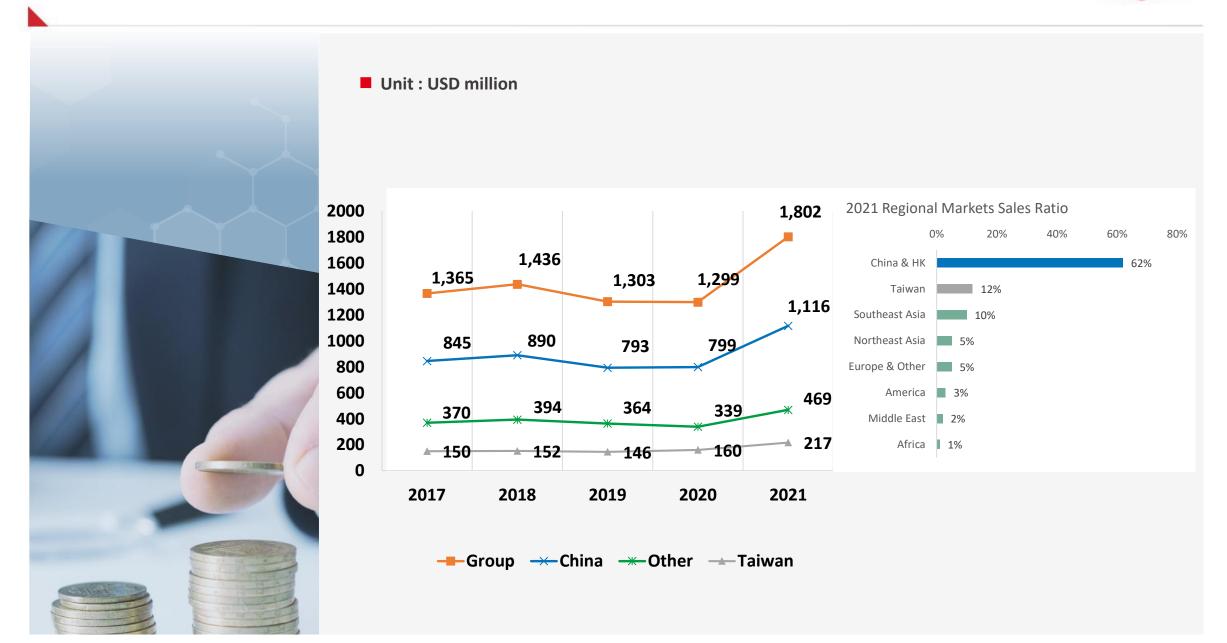
2021 Product Lines Sales Ratio





Annual Sales Distribution, 2021 Regional Markets Sales Ratio









Financial Information-Balance Sheets & Key Indices



	2022Q2		2021		2020		
	Amount	%	Amount	%	Amount	%	
Cash and cash equivalents and current financial assets	6,221	<u>10</u>	4,444	<u>7</u>	6,170	<u>11</u>	
Accounts receivable	19,151	<u>30</u>	20,071	<u>33</u>	17,523	<u>31</u>	
Inventories	12,053	<u>19</u>	10,678	<u>18</u>	7,493	<u>13</u>	
Financial assets	3,476	<u>6</u>	3,506	<u>6</u>	3,344	<u>6</u>	
Property, plant and equipment	16,770	<u>27</u>	16,369	<u>27</u>	16,623	<u>30</u>	
otal Assets	63,022	<u>100</u>	60,536	<u>100</u>	56,189	<u>100</u>	
Short-term borrowings	6,494	<u>10</u>	4,588	<u>8</u>	4,404	<u>8</u>	
Current portion of long-term borrowings	4,315	<u>7</u>	4,326	<u>7</u>	2,211	<u>4</u>	
Long-term borrowings	11,717	<u>19</u>	12,506	<u>21</u>	13,185	<u>23</u>	
otal Liabilities	38,184	<u>61</u>	35,869	<u>59</u>	32,950	<u>59</u>	
otal Equity	24,839	<u>39</u>	24,667	<u>41</u>	23,238	<u>41</u>	
ey Financial Ratios							
Average cash collection days	142		138	138		159	
Average days required for sale	106		85	85		93	
Current ratio (%)	171	_	190)	210		

Financial Information-Statements of Comprehensive Income



	2022 Q 2		2021	2021		2020	
	Amount	%	Amount	%	Amount	%	
Operating Revenue	25,549	100	50,471	100	38,370	100	
Gross profit	5,644	22	10,694	21	8,886	23	
Operating expenses	(3,466)	(14)	(6,599)	(13)	(5,747)	(15)	
Operating Income	2,178	9	4,095	8	3,139	8	
Non-operating income and expenses	115	0	337	1	6	0	
Net profit attributable to owners of the company	1780		3,549	3,549		2,543	
Key Financial Ratios							
Net profit margin (%)	7		7	7		6	
:PS	1.43		2.86	2.86		2.05	
ROE (%)	14		14		11		

Financial Information-Cash Flow Statements



	2022Q2	2021	2020	Unit : TWD M
	Amount	Amount	Amount	
Cash and cash equivalents at the beginning of the year	4,289	6,108	6,010	
Cash flows from operating activities	1,896	750	4,148	
Acquisition of property, plant and equipment	(1,314)	(2,049)	(1,458)	_
Increase (decrease) in borrowings	986	1,743	(997)	
Dividends paid	0	(1,860)	(1,736)	
Other items	14	(216)	134	
Effects of exchange rate changes on cash and cash equivalents	68	(187)	7	
Cash and cash equivalents at the end of the period	5,939	4,289	6,108	
ree cash flow	582	(1,299)	2,690	

Note. Free cash flow=

Cash flows from operating activities - Acquisition of property, plant and equipment







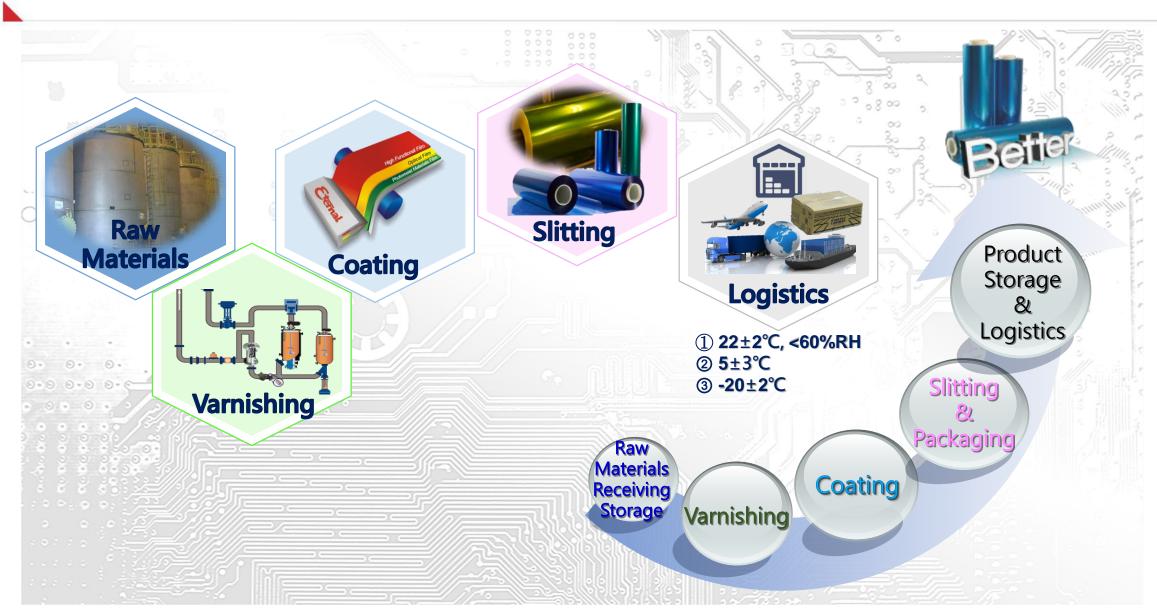
Photoresist Materials Division-Product Category





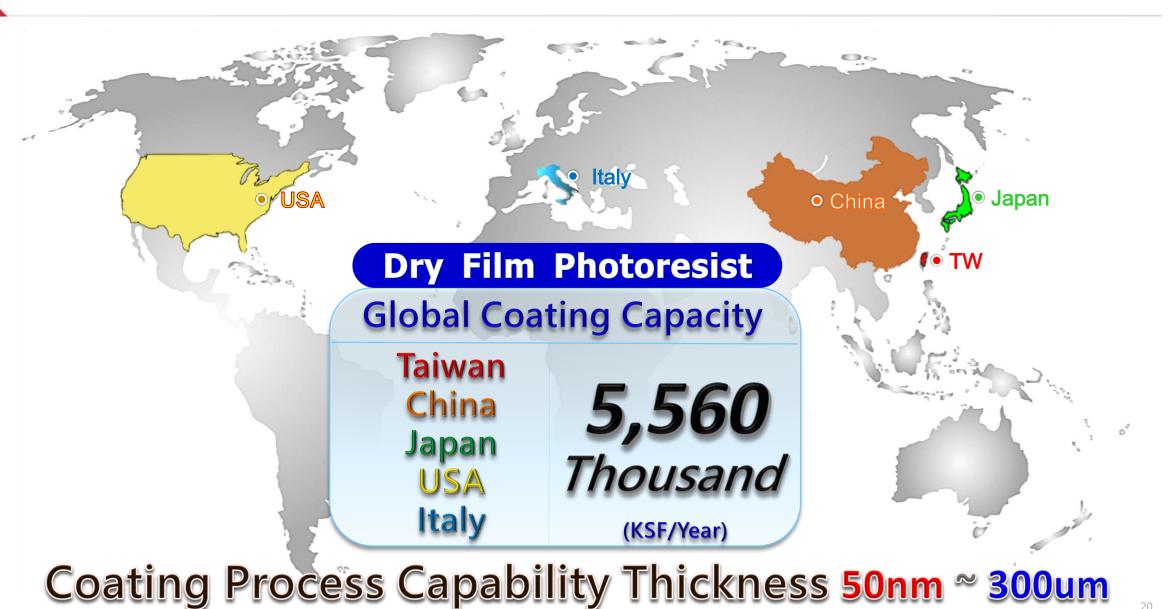
Photoresist Materials Division-One-Stop Service





Photoresist Materials Division-Global Coating Capacity





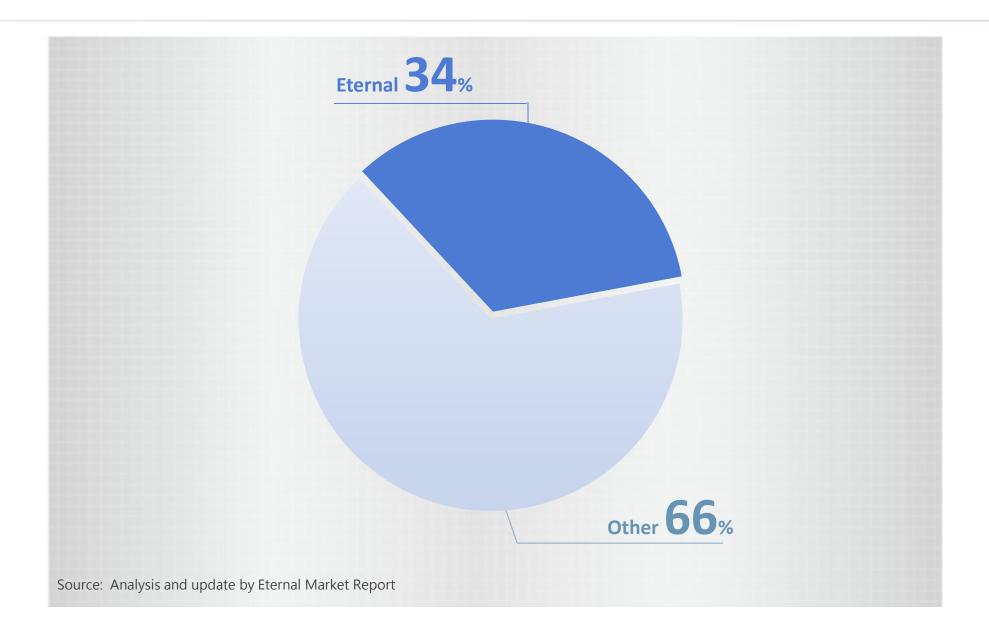
Photoresist Materials Division-Global Layout





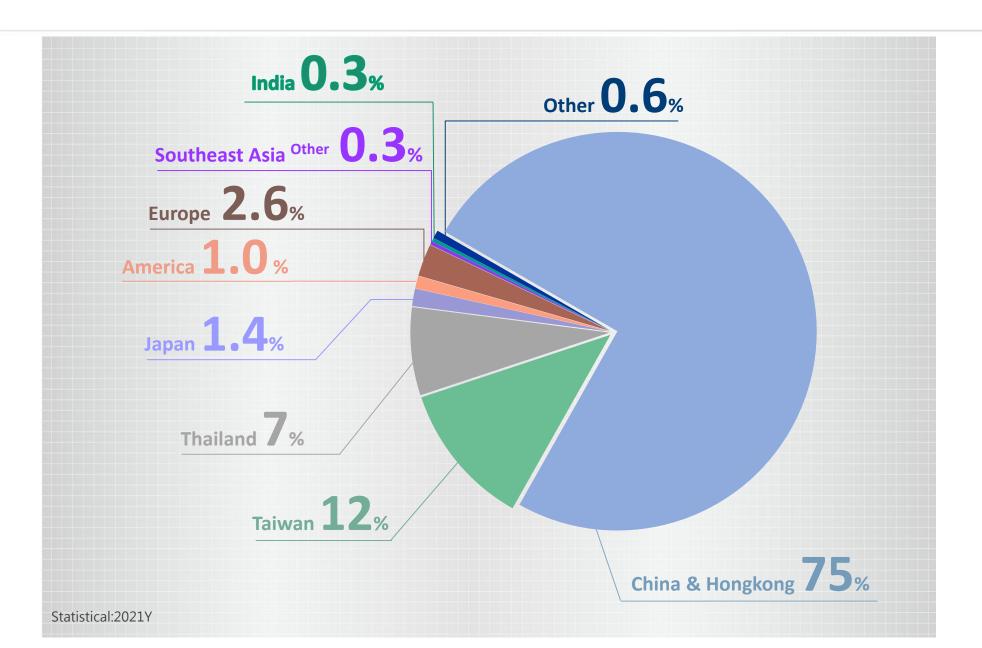
Photoresist Materials Division-Dry Film Market Share





Photoresist Materials Division-Dry Film Regional Markets Sales Ratio





Photoresist Materials Division-Related Certificates











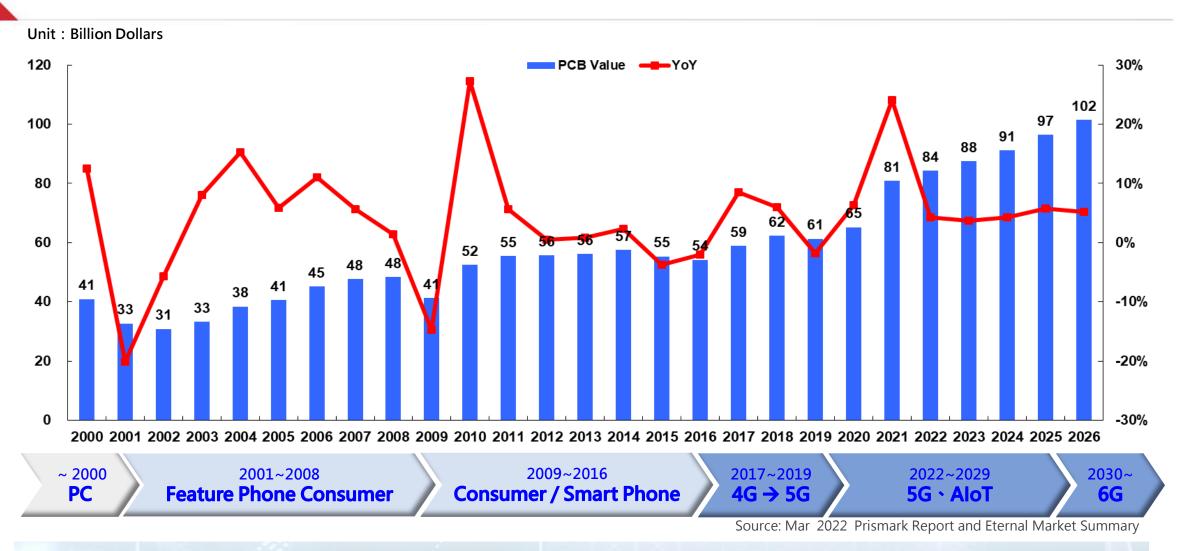






Global PCB Market Forecast (2021~2026)





COVID-19, Ukraine conflict, inflation impact of electronic industry of 2022, Prismrk forecast the PCB annual growth rate (CAGR 2021~2026) of 4.6%, driving by 5G, AloT and HPC, Smart Car related products in the next five years.

PCB Product Market Trend (2021~2026)

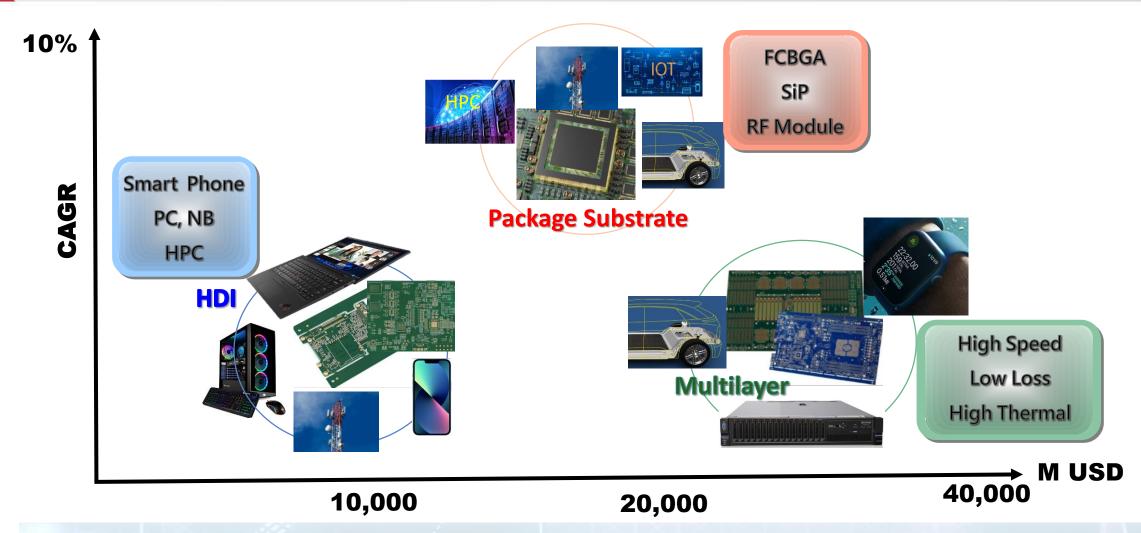


ITEM	SS/DS	ML	HDI	IC Substrate	FPC	
Product			FCCC			
Structure						
Application	Consumer		Smart phone, PC, NB, HPC, Smart Car	Smart Phone, Module NB, CPU, GPU, Automotive, Al	Automotive, LED lamp Antenna, SIM Card	
CAGR (2021~2026) * prismark report May 2022	2.4%	3.7%	4.9%	8.3%	4.1%	

Key drive of PCB Product in the future: IC substrate (CAGR=8.3%), HDI and ML, FPC product

PCB High-Growth Product & Application (2021~2026)

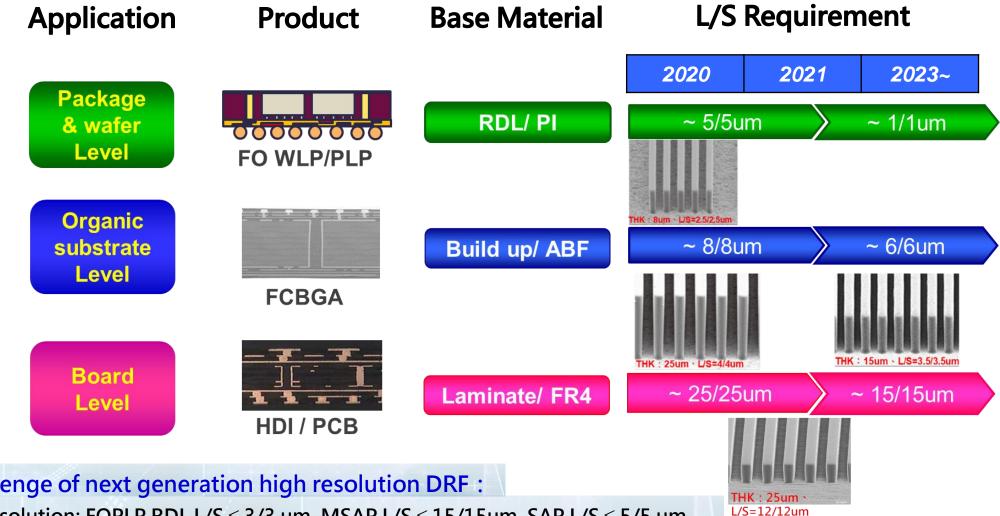




High growth products of PCB: IC substrate for FCBGA, SiP application, HDI for smart phone, HPC, NB, Automotive application and Multilayer PCB for high speed server application.

Eternal High Resolution DRF for PCB





Challenge of next generation high resolution DRF:

- Resolution: FOPLP RDL L/S \leq 3/3 um, MSAP L/S \leq 15/15um, SAP L/S \leq 5/5 um
- Adhesion on build up material: RDL (PI), Low Ra ABF materials
- New process control: new develop, stripping etc., process and equipment

Conclusion



1

COVID-19, Ukraine conflict, inflation impact of electronic industry of 2022, Prismrk forecast the PCB annual growth rate (CAGR 2021~2026) of 4.6%, driving by 5G, AloT and HPC, Smart Car related products in the future.

High growth products of PCB for next five years: IC
Substrate for FCBGA, SiP application, HDI for Smart Phone,
HPC, NB, Automotive application and Multilayer PCB for
high speed server application.



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Eternal high resolution DRF development for next generation PCB, will continue to provide the best service and solution for different kinds of etching and plating process for PCB and package substrate manufacturing.

